

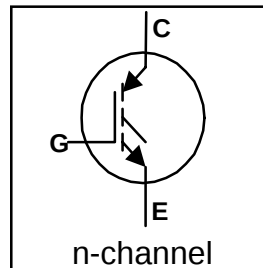
# IRGPS40B120U

INSULATED GATE BIPOLAR TRANSISTOR

UltraFast IGBT

## Features

- Low  $V_{CE(on)}$  Non Punch Through IGBT Technology
- 10 $\mu$ s Short Circuit Capability
- Square RBSOA
- Positive  $V_{CE(on)}$  Temperature Coefficient
- Super-247 Package



$$V_{CES} = 1200V$$

$$V_{CE(on)} \text{ typ.} = 3.12V$$

$$@V_{GE} = 15V, I_C = 40A$$

$$T_J = 25^\circ C$$

## Benefits

- Benchmark Efficiency above 20KHz
- Rugged Transient Performance
- Low EMI
- Excellent Current Sharing in Parallel Operation



## Absolute Maximum Ratings

|                             | Parameter                                                                                          | Max.                              | Units      |
|-----------------------------|----------------------------------------------------------------------------------------------------|-----------------------------------|------------|
| $V_{CES}$                   | Collector-to-Emitter Voltage                                                                       | 1200                              | V          |
| $I_C @ T_C = 25^\circ C$    | Continuous Collector Current                                                                       | 80                                | A          |
| $I_C @ T_C = 100^\circ C$   | Continuous Collector Current                                                                       | 40                                |            |
| $I_{CM}$                    | Pulsed Collector Current                                                                           | 160                               |            |
| $I_{LM}$                    | Clamped Inductive Load Current                                                                     | 160                               |            |
| $E_{AS} @ T_C = 25^\circ C$ | Avalanche Energy, single pulse<br>$I_C = 40 A, V_{CC} = 50V, R_{GE} = 5 \Omega$<br>$L = 200 \mu H$ | 160                               | mJ         |
| $V_{GE}$                    | Gate-to-Emitter Voltage                                                                            | $\pm 20$                          | V          |
| $P_D @ T_C = 25^\circ C$    | Maximum Power Dissipation                                                                          | 595                               | W          |
| $P_D @ T_C = 100^\circ C$   | Maximum Power Dissipation                                                                          | 238                               |            |
| $T_J$                       | Operating Junction and                                                                             | -55 to +150                       | $^\circ C$ |
| $T_{STG}$                   | Storage Temperature Range                                                                          |                                   |            |
|                             | Soldering Temperature, for 10 sec.                                                                 | 300 (0.063 in. (1.6mm) from case) |            |

## Thermal Resistance

|                 | Parameter                                 | Min. | Typ. | Max. | Units  |
|-----------------|-------------------------------------------|------|------|------|--------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | —    | —    | 0.21 |        |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface       | —    | 0.24 | —    |        |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | —    | —    | 40   |        |
| $W_t$           | Weight                                    | —    | 6.0  | —    | g (oz) |
| $L_E$           | Internal Emitter Inductance               | —    | 13   | —    | nH     |

Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

|                     | Parameter                               | Min. | Typ. | Max.      | Units                | Conditions                                                         | Ref. Fig. |
|---------------------|-----------------------------------------|------|------|-----------|----------------------|--------------------------------------------------------------------|-----------|
| $V_{(BR)CES}$       | Collector-to-Emitter Breakdown Voltage  | 1200 |      |           | V                    | $V_{GE} = 0V, I_C = 500 \mu A$                                     |           |
| $V_{(BR)CES} / T_J$ | Temperature Coeff. of Breakdown Voltage |      | 0.4  |           | V/ $^\circ\text{C}$  | $V_{GE} = 0V, I_C = 1 \text{ mA}$ ( 25 -125 $^\circ\text{C}$ )     |           |
| $V_{CE(on)}$        | Collector-to-Emitter Saturation Voltage |      | 3.12 | 3.50      | V                    | $I_C = 40A, V_{GE} = 15V$                                          |           |
|                     |                                         |      | 3.41 | 3.85      |                      | $I_C = 50A, V_{GE} = 15V$                                          |           |
|                     |                                         |      | 3.87 | 4.55      |                      | $I_C = 40A, V_{GE} = 15V, T_J = 125^\circ\text{C}$                 |           |
|                     |                                         |      | 4.26 | 5.10      |                      | $I_C = 50A, V_{GE} = 15V, T_J = 125^\circ\text{C}$                 |           |
| $V_{GE(th)}$        | Gate Threshold Voltage                  | 4.0  | 5.0  | 6.0       | V                    | $V_{CE} = V_{GE}, I_C = 250 \mu A$                                 |           |
|                     | Temperature Coeff. of Threshold Voltage |      | -12  |           | mV/ $^\circ\text{C}$ | $V_{CE} = V_{GE}, I_C = 1 \text{ mA}$ ( 25 -125 $^\circ\text{C}$ ) |           |
| $g_{fe}$            | Forward Transconductance                |      | 30.5 |           | S                    | $V_{CE} = 50V, I_C = 40A, PW = 80 \mu s$                           |           |
| $I_{CES}$           | Zero Gate Voltage Collector Current     |      | 15   |           | $\mu A$              | $V_{GE} = 0V, V_{CE} = 1200V$                                      |           |
|                     |                                         |      | 500  |           |                      | $V_{GE} = 0V, V_{CE} = 1200V, T_J = 125^\circ\text{C}$             |           |
|                     |                                         |      |      |           |                      |                                                                    |           |
| $I_{GES}$           | Gate-to-Emitter Leakage Current         |      |      | $\pm 100$ | nA                   | $V_{GE} = \pm 20V$                                                 |           |

Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

|              | Parameter                         | Min.        | Typ. | Max. | Units   | Conditions                                                                                                                 | Ref. Fig. |
|--------------|-----------------------------------|-------------|------|------|---------|----------------------------------------------------------------------------------------------------------------------------|-----------|
| $Q_g$        | Total Gate charge (turn-on)       |             | 340  |      | nC      | $I_C = 40A$                                                                                                                |           |
| $Q_{ge}$     | Gate - Emitter Charge (turn-on)   |             | 40   |      |         | $V_{CC} = 400V$                                                                                                            |           |
| $Q_{gc}$     | Gate - Collector Charge (turn-on) |             | 165  |      |         | $V_{GE} = 15V$                                                                                                             |           |
| $E_{on}$     | Turn-On Switching Loss *          |             | 1515 |      | $\mu J$ | $I_C = 40A, V_{CC} = 600V$                                                                                                 |           |
| $E_{off}$    | Turn-Off Switching Loss *         |             | 1783 |      |         | $V_{GE} = 15V, R_g = 4.7 \Omega, L = 200\mu H, L_s = 150nH$                                                                |           |
| $E_{tot}$    | Total Switching Loss *            |             | 3300 |      |         | $T_J = 25^\circ\text{C}$ , Energy losses include tail and diode reverse recovery                                           |           |
| $t_{d(on)}$  | Turn - on delay time              |             | 76   |      | ns      | $I_C = 40A, V_{CC} = 600V$                                                                                                 |           |
| $t_r$        | Rise time                         |             | 38   |      |         | $V_{GE} = 15V, R_g = 4.7 \Omega, L = 200\mu H, L_s = 150nH$                                                                |           |
| $t_{d(off)}$ | Turn - off delay time             |             | 292  |      |         | $T_J = 25^\circ\text{C}$ ,                                                                                                 |           |
| $t_f$        | Fall time                         |             | 22   |      |         |                                                                                                                            |           |
| $E_{on}$     | Turn-on Switching Loss *          |             | 2273 |      | $\mu J$ | $I_C = 40A, V_{CC} = 600V$                                                                                                 | 1         |
| $E_{off}$    | Turn-off Switching Loss *         |             | 2500 |      |         | $V_{GE} = 15V, R_g = 4.7 \Omega, L = 200\mu H, L_s = 150nH$                                                                | 2         |
| $E_{tot}$    | Total Switching Loss *            |             | 4772 |      |         | $T_J = 125^\circ\text{C}$ , Energy losses include tail and diode reverse recovery                                          | 3         |
| $t_{d(on)}$  | Turn - on delay time              |             | 76   |      | ns      | $I_C = 40A, V_{CC} = 600V$                                                                                                 |           |
| $t_r$        | Rise time                         |             | 39   |      |         | $V_{GE} = 15V, R_g = 4.7 \Omega, L = 200\mu H, L_s = 150nH$                                                                |           |
| $t_{d(off)}$ | Turn - off delay time             |             | 332  |      |         | $T_J = 125^\circ\text{C}$ ,                                                                                                |           |
| $t_f$        | Fall time                         |             | 25   |      |         |                                                                                                                            |           |
| $C_{ies}$    | Input Capacitance                 |             | 4400 |      | pF      | $V_{GE} = 0V$                                                                                                              |           |
| $C_{oes}$    | Output Capacitance                |             | 420  |      |         | $V_{CC} = 30V$                                                                                                             |           |
| $C_{res}$    | Reverse Transfer Capacitance      |             | 170  |      |         | $f = 1.0 \text{ MHz}$                                                                                                      |           |
| RBSOA        | Reverse bias safe operating area  | FULL SQUARE |      |      |         | $T_J = 150^\circ\text{C}, I_C = 160A$<br>$V_{CC} = 1000V, V_P = 1200V$<br>$R_g = 4.7 \Omega, V_{GE} = +15V \text{ to } 0V$ |           |
| SCSOA        | Short Circuit Safe Operating Area | 10          | ---- | ---- | $\mu s$ | $T_J = 150^\circ\text{C}$<br>$V_{CC} = 900V, V_P = 1200V$<br>$R_g = 22 \Omega, V_{GE} = +15V \text{ to } 0V$               |           |

\* Used Diode HF40D120ACE

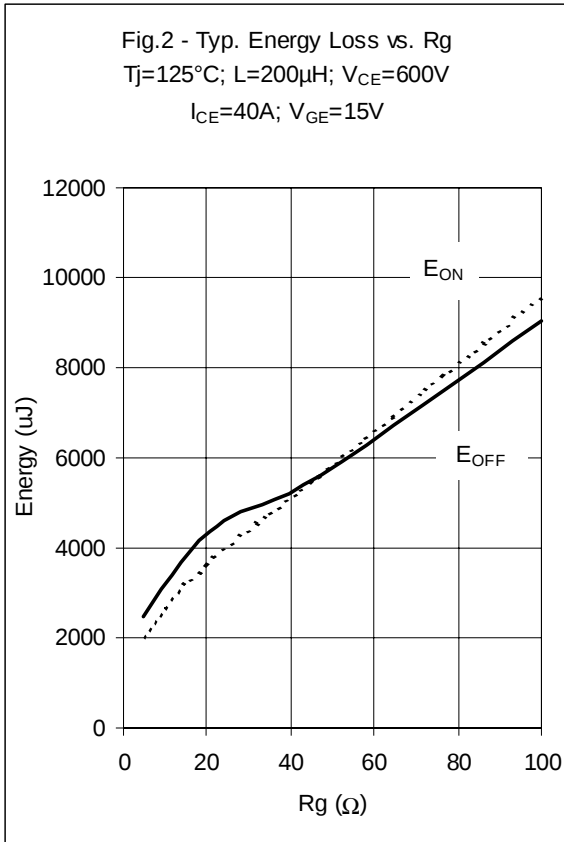
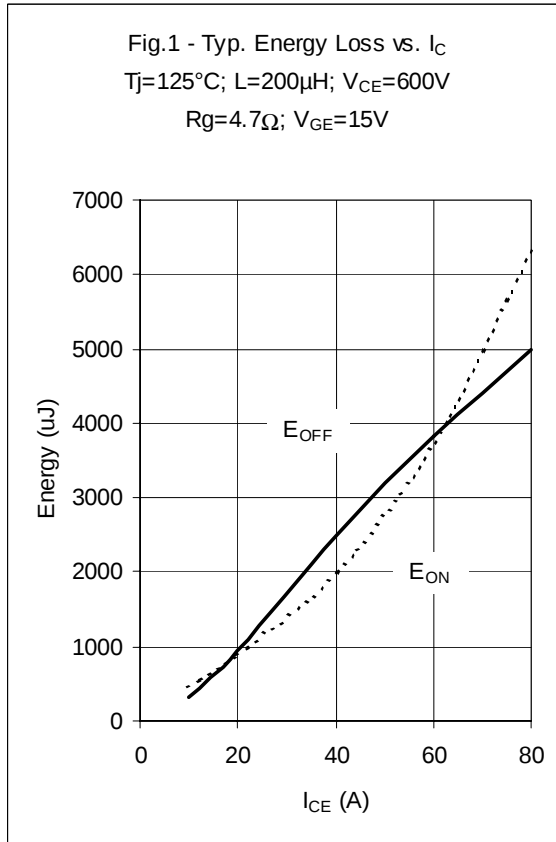
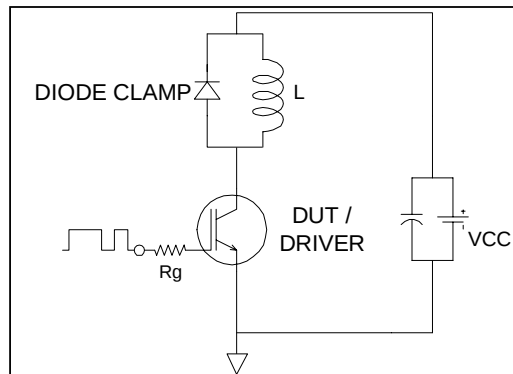


Fig.3 - Switching Loss Circuit

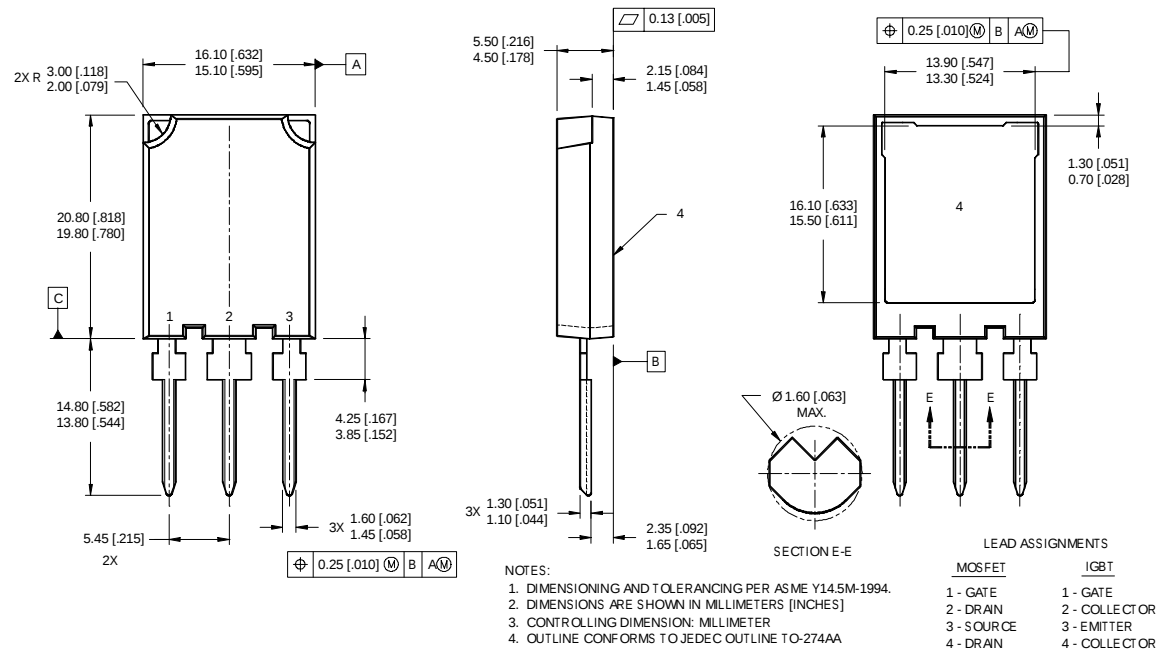


# IRGPS40B120U

PROVISIONAL

International  
**IR** Rectifier

## Super-247™ Package Outline



Data and specifications subject to change without notice.  
This product has been designed and qualified for the Industrial market.  
Qualification Standards can be found on IR's Web site.

International  
**IR** Rectifier

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